

Product Compliance Declaration

Please see www.molex.com for the most up-to-date information.

Contact Information

Name Molex Product Compliance E-Mail Product.Compliance@molex.com

Part Information

Part Name 16CKT R/A MINI FIT CONN.

Product Composition

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)	
16CKT R/A MINI FIT CONN.	Assembly		100	5.436032	
NEW MINIFIT CONN R/A WAFE	Component		42.3103	2.3	
PA66 NATURAL	Material		42.3103	2.3	
PA66	Substance		40.1948	2.185	
Further Additives, not to declare	Substance	system	2.1155	0.115	
1.07 SQ WIRE PIN(PLATED)	Assembly		35.7617	1.944016	
1.07 SQ WIRE PIN(UNPLATE	Assembly		35.7614	1.944	
1.07 SQ WIRE PIN(UNPLATE	Component		35.7614	1.944	
C2700	Material		35.7614	1.944	
Copper	Substance	7440-50-8	23.2449	1.2636	
Zinc (metal)	Substance	7440-66-6	12.4986	0.679428	
Lead	Substance	7439-92-1	0.0089	0.000486	
Iron	Substance	7439-89-6	0.0089	0.000486	

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Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)	
Copper Plating	Material		0.0001	0.000008	
Copper	Substance	7440-50-8	0.0001	0.000008	
Tin Plating	Material		0.0001		
Tin	Substance	7440-31-5	7440-31-5 0.0001		
1.07 SQ WIRE PIN(PLATED)	Assembly		21.9281		
1.07 SQ WIRE PIN	Assembly		21.9278		
1.07 SQ WIRE PIN	Component		21.9278	1.192	
C2700	Material		21.9278	1.192	
Copper	Substance	7440-50-8	14.253	0.7748	
Zinc (metal)	Substance	7440-66-6	7440-66-6 7.6638		
Lead	Substance	7439-92-1	7439-92-1 0.0055		
Iron	Substance	7439-89-6	0.0055	0.000298	
Copper Plating	Material		0.0001		
Copper	Substance	7440-50-8	7440-50-8 0.0001		
Tin Plating	Material		0.0001		
Tin	Substance	7440-31-5	0.0001	0.000008	

GADSL Declaration Information

Regulatory Revision GADSL imported from IMDS

Contained Substances Exceeding Threshold

Not reviewed

ROHS Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

Contained Substances Exceeding Threshold

None

Exemptions

None

REACH-SVHC Declaration Information

Regulatory Revision D(2020)9139-DC (19 Jan 2021)

Contained Substances Exceeding Threshold

None

HFLH Declaration Information

Regulatory Revision IEC 61249-2-21

Contained Substances Exceeding Threshold

None

China ROHS Declaration Information

Part Number 0353181620

Part Name 16CKT R/A MINI FIT CONN.



Hazardous Substances

	114241 4040 04504411000					
Components	Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
16CKT R/A MINI FIT CONN.	0	0	0	0	0	0
NEW MINIFIT CONN R/A WAFE	0	0	0	0	0	0

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Components	Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
1.07 SQ WIRE PIN(PLATED)	0	0	0	0	0	0
1.07 SQ WIRE PIN(UNPLATE	0	0	0	0	0	0
1.07 SQ WIRE PIN(UNPLATE	0	0	0	0	0	0
1.07 SQ WIRE PIN(PLATED)	0	0	0	0	0	0
1.07 SQ WIRE PIN	0	0	0	0	0	0
1.07 SQ WIRE PIN	0	0	0	0	0	0

Process Information

Component Plating / Surface Finish	SnCu
Termination Base Alloy	Brass
Solder Alloy	SnAgCu
Process Capability	N/A
Maximum Exposure Time (seconds)	N/A
Maximum Process Temperature (C)	N/A
Maximum Cycles at Reflow Temperature	N/A
J-STD-020 Moisture Sensitivity Level	N/A

Mar 24, 2021